

Title (en)  
ENCLOSURE FOR HARDWARE

Title (de)  
GEHÄUSE FÜR HARDWARE

Title (fr)  
ENCEINTE POUR MATERIEL

Publication  
**EP 1161784 A1 20011212 (EN)**

Application  
**EP 00911035 A 20000320**

Priority  
• GB 0000950 W 20000320  
• GB 9906082 A 19990318

Abstract (en)  
[origin: WO0055951A1] An enclosure (1) for conduction-cooled hardware comprises a frame of corner pieces (2) and intermediate linking pieces (3). The corner pieces (2) (and maybe the pieces (3)) are formed by casting and machining. Panels are added to this frame to complete the enclosure (1). The corner pieces (2) have projecting portions that project through a significant distance. A range of different-sized linking pieces is provided so that different-sized enclosures can be assembled.

IPC 1-7  
**H02B 1/30**

IPC 8 full level  
**H02B 1/30** (2006.01); **H02B 1/01** (2006.01)

CPC (source: EP)  
**H02B 1/301** (2013.01); **H02B 1/014** (2013.01)

Citation (search report)  
See references of WO 0055951A1

Designated contracting state (EPC)  
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**WO 0055951 A1 20000921**; AU 3303500 A 20001004; CA 2402376 A1 20010921; EP 1161784 A1 20011212; GB 9906082 D0 19990512

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